

CRMKGL0612A

N-Channel 60V, 12mΩ Typ. Power MOSFET

Description

Features

• 60V, 40A

 $R_{DS(ON)}$ Typ =12m Ω @ V_{GS} = 10V

 $R_{DS(ON)}$ Typ =16m Ω @ V_{GS} = 4.5V

- Advanced Split Gate Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

Application

- Load Switch
- PWM Application
- Power Management

G S S



Schematic Diagram

Marking and Pin Assignment

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Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKGL0612A	CRMKGL0612A	TO-252-3L	TAPING	13"	2500	25000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		60	V
V _{GS}	Gate-to-Source Voltage		±20	V
Ι _D	Continuous Drain Current	T _C = 25°C	40	А
		T _C = 100°C	24	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		160	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		36	mJ
P _D	Power Dissipation	T _C = 25°C	44.6	W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		2.8	°C/W
T J, T _{STG}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{\rm D}$ = 250 μ A, $V_{\rm GS}$ = 0V	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60V, V _{GS} = 0V	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	1.0	1.3	1.8	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 20A	-	12	16	mΩ
		V _{GS} = 4.5V, I _D = 10A	-	16	21	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	600	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz	Χ-	256	-	pF
C _{rss}	Reverse Transfer Capacitance	1 - 110112	-	6	-	pF
Q _g	Total Gate Charge		J -	13.9	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 30V$, $I_{D} = 20A$	-	1.6	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 30 v$, $v_{\rm D} = 20 A$	-	3.1	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	3.7	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 30V	-	4.3	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 6 Ω	-	16.2	-	ns
t _f	Turn-Off Fall Time		-	6.5	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _s	Maximum Continuous Drain to Source Diode Forward Current			-	40	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	160	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 20A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	24	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 15A, di/dt = 100A/us	-	9.3	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J=25°C, V_{DD}=30V, V_G=10V, R_G=250hm, L=0.5mH, I_{AS}=12A

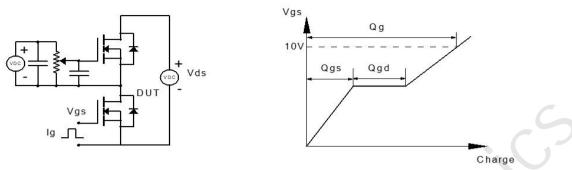
3. Pulse Test: Pulse Width ${\leqslant}300\mu s,$ Duty Cycle ${\leqslant}0.5\%.$

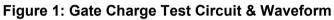


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Test Circuit





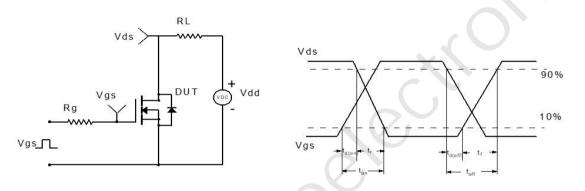


Figure 2: Resistive Switching Test Circuit & Waveform

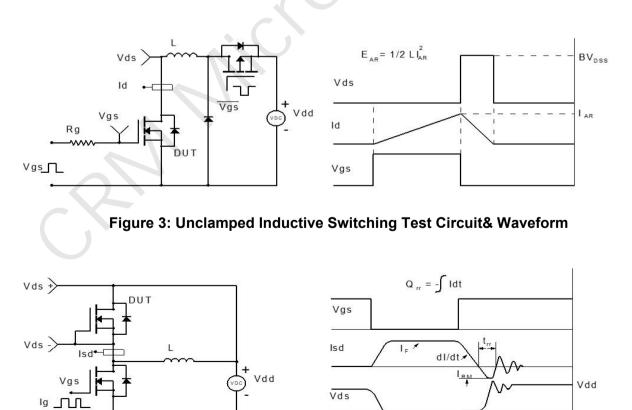
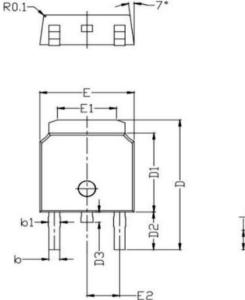
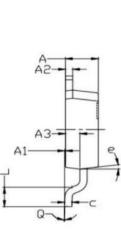


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(TO-252-3L)





COMMON DIMENSION(MM)							
MIN	MON	MAX					
2.250	2.300	2.400					
0.010	0.060	0.150					
0.500	0.508	0.550					
0.960	1.010	1.060					
0.740	0.760	0.800					
0.880	0.900	0.950					
0.500	0.508	0.550					
9.800	10.025	10.350					
6.050	6.100	6.180					
2.850	2.900	2.950					
0.700	0.800	2.900					
6.550	6.600	6.700					
4.050	4.130	4.200					
2.250	2.286	2.300					
1.400	1.500	1.600					
7.000							
0°	2°	5°					
	MIN 2.250 0.010 0.500 0.960 0.740 0.880 0.500 9.800 6.050 2.850 0.700 6.550 4.050 2.250 1.400	TO-252-31 MIN MON 2.250 2.300 0.010 0.060 0.500 0.508 0.960 1.010 0.740 0.760 0.880 0.900 0.500 0.508 9.800 10.025 6.050 6.100 2.850 2.900 0.700 0.800 6.550 6.600 4.050 4.130 2.250 2.286 1.400 1.500					

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